

# **DTA144E** series

PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Datasheet

Parameter	Value
V <sub>CC</sub>	-50V
I <sub>C(MAX.)</sub>	-100mA
R <sub>1</sub>	47kΩ
R <sub>2</sub>	47kΩ

## Features

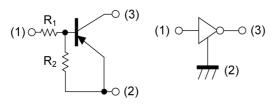
- 1) Built-In Biasing Resistors,  $R_1 = R_2 = 47k\Omega$
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC144E series

## Application

INVERTER, INTERFACE, DRIVER

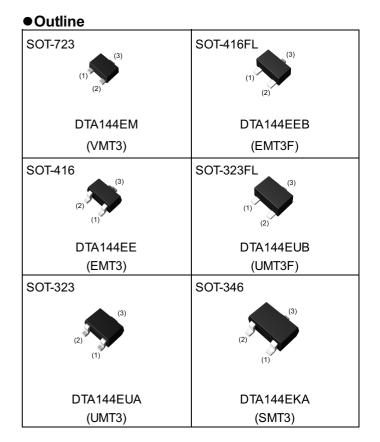
### Inner circuit

DTA144EM/ DTA144EEB/ DTA144EUB

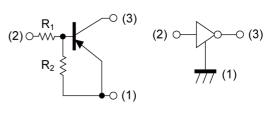


(1) IN (BASE)
(2) GND (+) (EMITTER)
(3) OUT (COLLECTOR)

## Packaging specifications



## DTA144EE/ DTA144EUA/ DTA144EKA



(1) GND (+) (EMITTER) (2) IN (BASE) (3) OUT (COLLECTOR)

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA144EM	SOT-723	1212	T2L	180	8	8000	16
DTA144EEB	SOT-416FL	1616	TL	180	8	3000	16
DTA144EE	SOT-416	1616	TL	180	8	3000	16
DTA144EUB	SOT-323FL	2021	TL	180	8	3000	16
DTA144EUA	SOT-323	2021	T106	180	8	3000	16
DTA144EKA	SOT-346	2928	T146	180	8	3000	16

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

F	Parameter	Symbol	Values	Unit
Supply voltage	V <sub>CC</sub>	-50	V	
Input voltage		V <sub>IN</sub>	-40 to 10	V
Output current		Ι <sub>ο</sub>	-30	mA
Collector current	Collector current			mA
	DTA144EM		150	
	DTA144EEB		150	
Dower discipation	DTA144EE		150	
Power dissipation	DTA144EUB		200	— mW
	DTA144EUA		200	
	DTA144EKA		200	
Junction temperature		Tj	150	°C
Range of storage tempera	ature	T <sub>stg</sub>	-55 to +150	°C

## •Electrical characteristics (T<sub>a</sub> = 25°C)

Demonster	Ourseland	Qualities	Values			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
	V <sub>I(off)</sub>	V <sub>CC</sub> = -5V, I <sub>O</sub> = -100µA	-	-	-0.5	N
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = -0.3V, I <sub>O</sub> = -2mA	-3.0	-	-	V
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -10mA, I <sub>I</sub> = -0.5mA	-	-100	-300	mV
Input current	I <sub>I</sub>	V <sub>I</sub> = -5V	-	-	-180	μA
Output current	I <sub>O(off)</sub>	V <sub>CC</sub> = -50V, V <sub>I</sub> = 0V	-	-	-500	nA
DC current gain	G <sub>I</sub>	V <sub>O</sub> = -5V, I <sub>O</sub> = -5mA	68	-	-	-
Input resistance	R <sub>1</sub>	-	32.9	47	61.1	kΩ
Resistance ratio	$R_2/R_1$	-	0.8	1.0	1.2	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz

\*1 Characteristics of built-in transistor

\*2 Each terminal mounted on a reference land.



## •Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

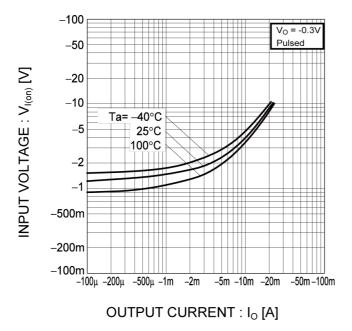


Fig.2 Output current vs. input voltage (OFF characteristics)

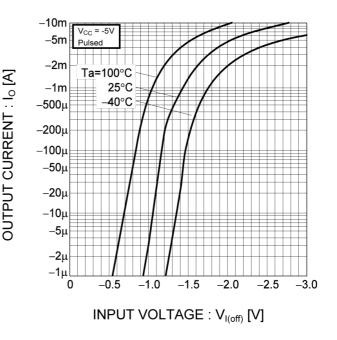


Fig.3 Output current vs. output voltage

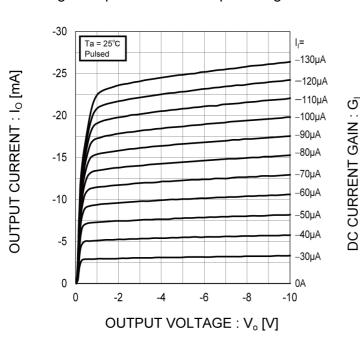
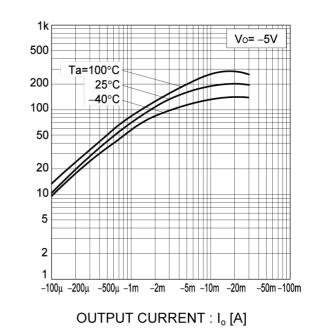
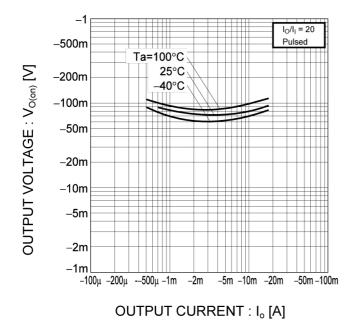


Fig.4 DC current gain vs. output current





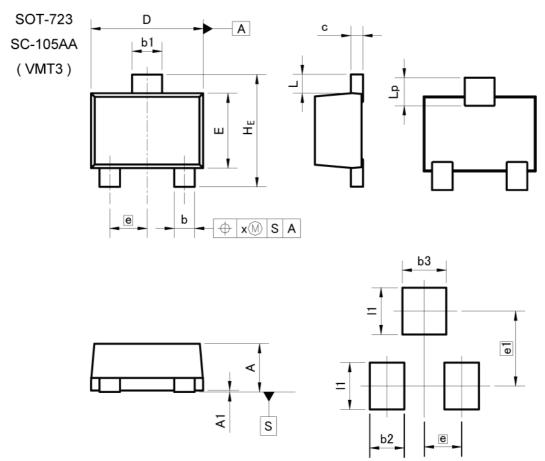
## •Electrical characteristic curves (T<sub>a</sub> =25°C)



### Fig.5 Output voltage vs. output current



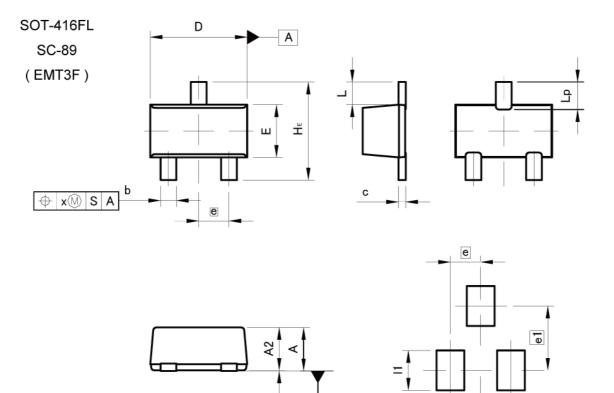




Pattern of terminal position areas [Not a pattern of soldering pads]

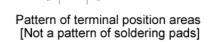
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
с	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
x	-	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	-	0.015
b3	-	0.47		0.019
e1	0.80		0.0	31
11		0.50		0.020





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b2

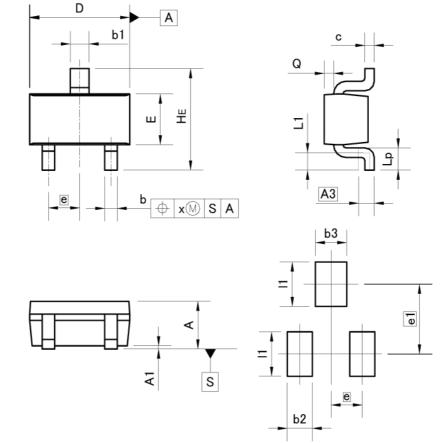
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
с	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.015	
Lp	0.35	0.55	0.014	0.022
x	—	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2		0.46	-	0.018
e1	-	1.05	—	0.041
- 11	-	0.65	-	0.026







(EMT3)

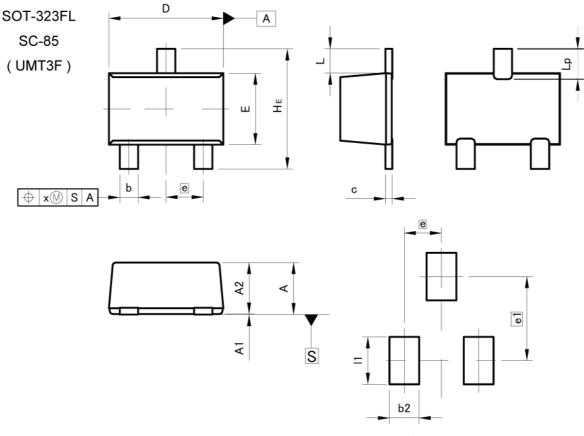


Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
Е	0.70	0.90	0.028	0.035
е	0.50		0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15	-	0.006	-
Q	0.05	0.25	0.002	0.010
х		0.10		0.004

DIM		INCHES		
	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	-	0.50	-	0.020
e1	1.	10	0.0	43
1	T.	0.70	-	0.028





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
A	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
с	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L	0.4	43	0.017	
Lp	0.43	0.63	0.017	0.025
x	-	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.52	-	0.020
e1	1.4	47	0.0	58
11	-	0.83	-	0.033





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
А	0.80	1.00	0.031	0.039
A1	0.00	0.10	0	0.004
A3	0.2	25	0.0	D1
b	0.25	0.40	0.01	0.016
с	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.0	03
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.02
Lp	0.25	0.55	0.01	0.022
Q	0.10	0.30	0.004	0.012
х	_	0.10	_	0.004

DIM MILIM		MILIMETERS		HES
		MAX	MIN	MAX
e1	1.55		0.06	
b2	-	0.50	-	0.02
1	-	0.65	-	0.026





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
А	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.1	25	0.0	)10
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.9	95	0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	—	0.10	-	0.004
У		0.10	-	0.004
DIM	MILIMET		INC	HES
			12 Constant and the second second	

DIM	MILIMETERS		INCHES	
DIN	MIN	MAX	MIN	MAX
b2	-	0.60	-	0.024
e1	2.10		0.083	
1	-	0.90	-	0.035



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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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